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## AMENDMENTS TO THE CLAIMS:

Claims 1-14 (Canceled)

- 15. (Currently amended) A semiconductor structure, comprising:
  - a substrate;
  - a crystalline oxide layer comprising single-crystal oxide formed over said an epitaxial silicon layer formed on said crystalline oxide layer.

ite; and

- 16. (Original) The structure of claim 15, further comprising:
  - a silicon oxide layer formed between said substrate and said crystalline ox

n oxide

er.

- 17. (Original) The structure of claim 15, wherein the crystalline oxide layer comp of at least one of the rare earth elements.
- 18. (Original) The structure of claim 15, wherein the crystalline oxide layer company of oxide of yttrium.
- 19. (Original) The structure of claim 15, wherein the crystalline oxide layer compared mixture of oxides of different rare earth elements and yttrium.
- 20. (Currently amended) The structure of claim 15, further comprising:

  at least one additional layer of crystalline oxide formed on said epitaxial structure and layer of circumstance at least one additional layer of silicon formed on said additional layer of circumstance.
- 21. (Currently amended) A semiconductor structure, comprising:
  a substrate;
  - a crystalline oxide layer comprising single-crystal oxide formed over said an epitaxial germanium layer formed on said crystalline oxide layer.

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22. (Original) The structure of claim 21, further comprising:

a silicon oxide layer formed between said substrate and said crystalline ox

23. (Original) The structure of claim 21, wherein the crystalline oxide layer compart of at least one of the rare earth elements.

24. (Original) The structure of claim 21, wherein the crystalline oxide layer composition of yttrium.

- 25. (Original) The structure of claim 21, wherein the crystalline oxide layer composition of oxides of different rare earth elements and yttrium.
- 26. (Currently amended) The structure of claim 21, further comprising:

  at least one additional layer of crystalline oxide formed on said epitaxial graduational layer; and

at least one additional layer of germanium formed on said additional layer oxide.

27. (Currently amended) A semiconductor structure, including:

a crystalline oxide surface <u>comprising a single-crystal oxide surface</u>; and an amorphous layer of at least one of silicon, germanium, gallium arsenic arsenide, indium phosphide, aluminum antimonide, indium arsenide, gallium phosphide alloys thereof, deposited on said crystalline oxide surface by evaporation vapor deposition.

Claims 28-55 (Canceled)

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56. (Previously presented) The structure of claim 15, wherein said substrate compassibstrate.

silicon

57. (Previously presented) The structure of claim 15, wherein said substrate comp germanium substrate.

a silicon

- 58. (Previously presented) The structure of claim 21, wherein said substrate computations substrate.
- 59. (Previously presented) The structure of claim 21, wherein said substrate comgermanium substrate.

er is

60. (Previously presented) The structure of claim 15, wherein said crystalline ox formed directly on said substrate.

er is

61. (Previously presented) The structure of claim 21, wherein said crystalline ox formed directly on said substrate.

rate,

62. (Previously presented) The structure of claim 27, further comprising a silico wherein said crystalline oxide surface is formed directly on said silicon substrate

er

63. (Previously presented) The structure of claim 15, wherein said epitaxial silic comprises a single-crystal epitaxial silicon layer.

n layer

64. (Previously presented) The structure of claim 21, wherein said epitaxial gern comprises a single-crystal epitaxial germanium layer.

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65. (Previously presented) The structure of claim 15, wherein said crystalline or

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comprises an epitaxial oxide layer.

- 66. (Previously presented) The structure of claim 21, wherein said crystalline oxid comprises an epitaxial oxide layer.
- 67. (Previously presented) The structure of claim 27, wherein said crystalline ox comprises an epitaxial oxide surface.
- 68. (Currently amended) The structure of claim 15, wherein said crystalline oxid comprises a mixture of oxides of different rare earth elements a single-crystal oxi
- 69. (Currently amended) The structure of claim 21, wherein said crystalline oxid comprises a mixture of oxides of different rare earth elements a single-crystal ox
- 70. (Currently amended) The structure of claim 27, wherein said crystalline oxid comprises a surface of a mixture of oxides of different rare earth elements a sing surface.
- 71. (Previously presented) The structure of claim 15, wherein said oxide layer c have a bixbyite structure.
- 72. (Previously presented) The structure of claim 21, wherein said oxide layer c have a bixbyite structure.
- 73. (Previously presented) The structure of claim 27, wherein said crystalline of crystallizes to have a bixbyite structure.
- 74. (Currently amended) The structure of claim 15, wherein said crystalline oxi

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perfectly exactly lattice-matched to silicon.

75. (Currently amended) The structure of claim 27, wherein said crystalline oxide perfectly exactly lattice-matched to silicon.